

Engineering Development Model

Power Splitter/Combiner

TRPS-ED12747/2

2 Way-0°

Important Note

This model has been designed, built and tested in our engineering department. Performance data represents model capability. At present it is a non-catalog model. On request, we can supply a final specification sheet, part number and price/delivery information.



Please click "Back", and then click "Contact Us" for Applications support.

CASE STYLE : AT577

ELECTRICAL SPECIFICATIONS 75Ω @ +25°C				
Parameter		Min.	Typ.	Max. Units
Frequency		0.5		400 MHz
Isolation	0.5 - 5 MHz		27	dB
	5 - 200 MHz		25	dB
	200 - 400 MHz		22	dB
Insertion Loss Above 3.0 dB	0.5 - 5 MHz		0.25	dB
	5 - 200 MHz		0.20	dB
	200 - 400 MHz		0.22	dB
Phase Unbalance	0.5 - 5 MHz		0.586	deg.
	5 - 200 MHz		0.184	deg.
	200 - 400 MHz		0.444	deg.
Amplitude Unbalance	0.5 - 5 MHz		0.121	dB
	5 - 200 MHz		0.064	dB
	200 - 400 MHz		0.072	dB
VSWR	SUM Port		1.10	(:1)
	OUT Ports		1.10	(:1)

MAXIMUM RATINGS	
Operating Temperature	-40°C to 85°C
Storage Temperature	-55°C to 100°C

PIN CONNECTIONS	
SUM PORT	1
PORT 1	6
PORT 2	3
GND EXT	2,5
50Ω TERMINATION	4

Functional Diagram



2 Way-0° Power Splitter/Combiner

TRPS-ED12747/2

Typical Performance Data

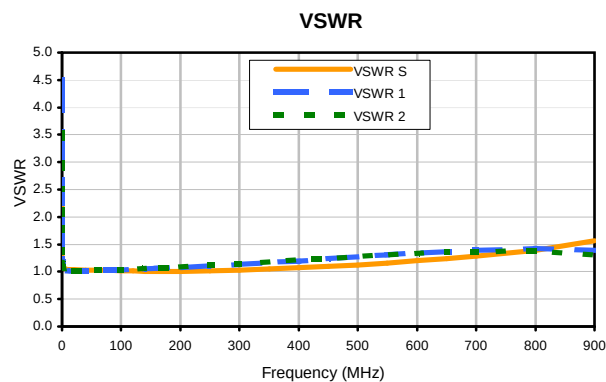
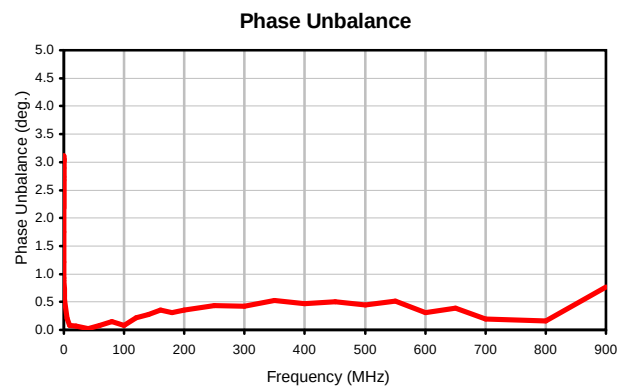
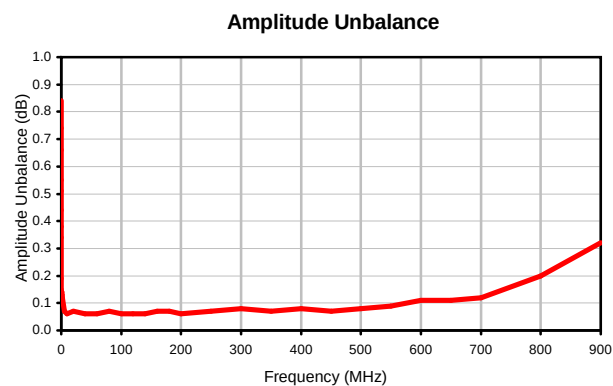
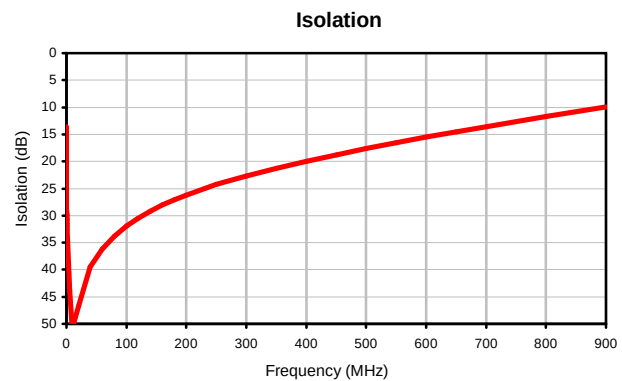
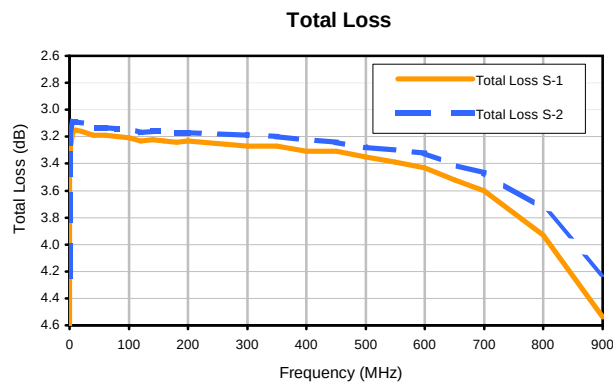
FREQ. (MHz)	TOTAL LOSS ¹ (dB)		AMP. UNBAL. (dB)	ISOLATION (dB)	PHASE UNBAL. (deg.)	FREQ. (MHz)	VSWR (:1)		
	S-1	S-2					S	1	2
0.1	5.08	4.24	0.84	13.54	2.17	0.1	2.44	4.50	3.54
0.1	4.55	3.81	0.74	14.00	2.68	0.1	2.09	3.58	2.89
0.1	4.23	3.57	0.66	14.61	3.05	0.1	1.88	3.03	2.51
0.1	4.00	3.45	0.55	15.28	3.11	0.1	1.73	2.67	2.25
0.1	3.86	3.35	0.51	15.96	3.01	0.1	1.62	2.41	2.06
0.1	3.74	3.30	0.44	16.65	3.05	0.1	1.54	2.21	1.92
0.1	3.66	3.28	0.38	17.32	2.90	0.1	1.48	2.06	1.81
0.1	3.60	3.26	0.34	17.96	2.74	0.1	1.43	1.94	1.72
0.2	3.43	3.24	0.19	22.77	1.75	0.2	1.23	1.44	1.35
0.3	3.39	3.23	0.15	25.59	1.21	0.3	1.16	1.30	1.24
0.4	3.35	3.21	0.14	27.45	0.93	0.4	1.14	1.24	1.19
0.5	3.33	3.20	0.13	28.83	0.88	0.5	1.12	1.20	1.16
0.6	3.33	3.19	0.14	29.89	0.73	0.6	1.11	1.18	1.14
0.7	3.32	3.18	0.13	30.72	0.62	0.7	1.10	1.16	1.12
0.8	3.31	3.18	0.13	31.43	0.59	0.8	1.10	1.15	1.11
0.9	3.30	3.18	0.12	32.06	0.53	0.9	1.09	1.14	1.10
1.0	3.29	3.17	0.13	32.60	0.54	1.0	1.09	1.13	1.10
5.0	3.17	3.09	0.07	43.80	0.21	5.0	1.05	1.04	1.03
10.0	3.15	3.09	0.06	50.83	0.08	10.0	1.04	1.02	1.02
20.0	3.16	3.10	0.07	46.70	0.07	20.0	1.04	1.01	1.02
40.0	3.19	3.13	0.06	39.49	0.02	40.0	1.03	1.01	1.02
60.0	3.19	3.13	0.06	36.14	0.08	60.0	1.03	1.02	1.03
80.0	3.20	3.14	0.07	33.75	0.15	80.0	1.03	1.03	1.04
100.0	3.21	3.14	0.06	31.91	0.08	100.0	1.02	1.03	1.04
120.0	3.23	3.17	0.06	30.44	0.22	120.0	1.02	1.04	1.05
140.0	3.22	3.16	0.06	29.14	0.28	140.0	1.01	1.05	1.06
160.0	3.23	3.16	0.07	28.06	0.35	160.0	1.01	1.06	1.07
180.0	3.24	3.17	0.07	27.06	0.31	180.0	1.01	1.07	1.08
200.0	3.23	3.17	0.06	26.19	0.36	200.0	1.01	1.08	1.09
250.0	3.25	3.18	0.07	24.28	0.44	250.0	1.02	1.11	1.12
300.0	3.27	3.19	0.08	22.67	0.42	300.0	1.03	1.13	1.14
350.0	3.27	3.20	0.07	21.24	0.53	350.0	1.05	1.17	1.18
400.0	3.31	3.22	0.08	19.96	0.47	400.0	1.07	1.19	1.21
450.0	3.31	3.24	0.07	18.75	0.50	450.0	1.10	1.24	1.24
500.0	3.35	3.28	0.08	17.59	0.45	500.0	1.12	1.27	1.27
550.0	3.39	3.30	0.09	16.51	0.52	550.0	1.16	1.31	1.31
600.0	3.43	3.32	0.11	15.48	0.31	600.0	1.20	1.34	1.33
650.0	3.52	3.41	0.11	14.52	0.39	650.0	1.24	1.37	1.36
700.0	3.60	3.47	0.12	13.55	0.20	700.0	1.28	1.39	1.37
800.0	3.93	3.73	0.20	11.69	0.16	800.0	1.39	1.42	1.38
900.0	4.54	4.22	0.32	9.87	0.77	900.0	1.57	1.39	1.31

¹ Total Loss = Insertion Loss + 3dB Splitter Loss

2 Way-0° Power Splitter/Combiner

TRPS-ED12747/2

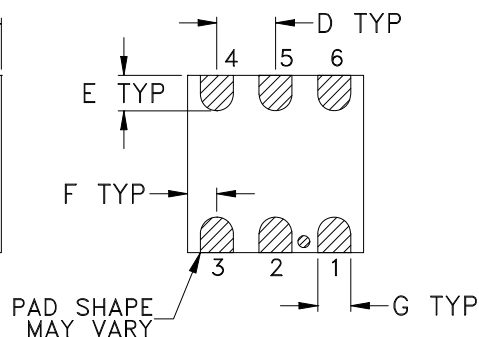
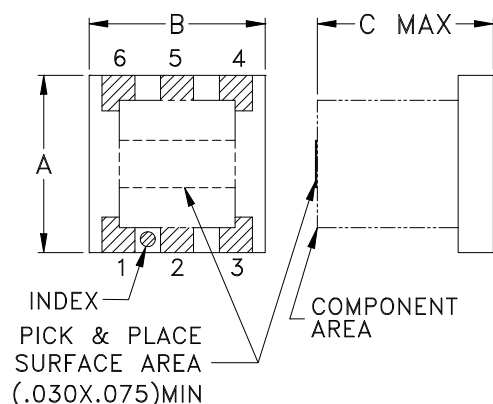
Typical Performance Curves



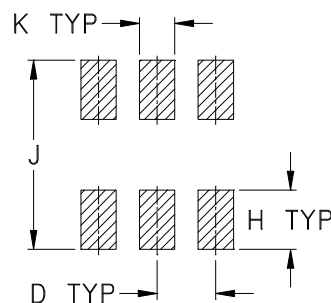
REV. X2
TRPS-ED12747/2
100707
Page 1 of 1

Outline Dimensions

AT577



PCB Land Pattern



Suggested Layout,
Tolerance to be within $\pm .002$

CASE #	A	B	C	D	E	F	G	H	J	K	L	WT. GRAMS
AT577	.200 (5.08)	.200 (5.08)	.200 (5.08)	.075 (1.91)	.050 (1.27)	.025 (0.64)	.026 (0.66)	.070 (1.78)	.220 (5.59)	.035 (0.89)	-- --	.15

Dimensions are in inches (mm). Tolerances: 2 Pl. $\pm .01$; 3 Pl. $\pm .005$

Notes:

- Open style, ceramic base.
- Termination finish:
For RoHS Case Style: 2-10 μ inch (.05-.25 microns) Gold over 100-300 μ inch (2.54-7.62 microns) Nickel plate.
For RoHS-5 Case Style: Tin-Lead plate



P.O. Box 350186, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site

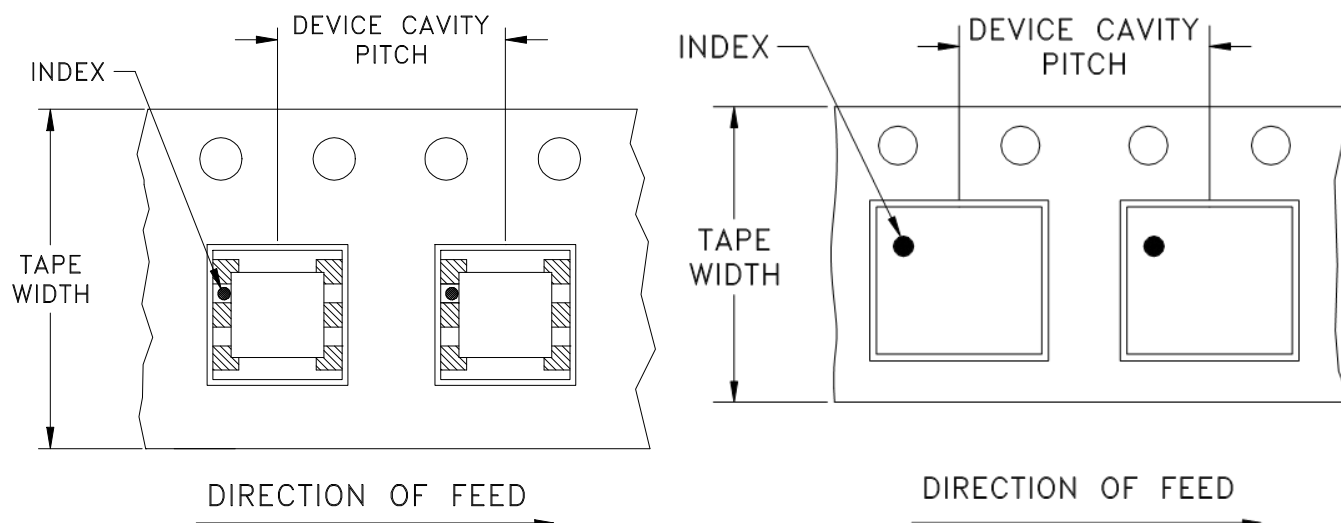


The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

RF/IF MICROWAVE COMPONENTS

Tape & Reel Packaging TR-F73

DEVICE ORIENTATION IN T&R



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
12	8	7	Small quantity standards (see note)	20
				50
				100
				200
				500
		13	Standard	1000
				2000

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf



INTERNET <http://www.minicircuits.com>

P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661

Distribution Centers NORTH AMERICA 800-654-7949 • 417-335-5935 • Fax 417-335-5945 • EUROPE 44-1252-832600 • Fax 44-1252-837010

Mini-Circuits ISO 9001 & ISO 14001 Certified



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215